

AN-284 Single-Supply Applications of CMOS MICRODACs

ABSTRACT

CMOS data acquisition and conversion products are becoming the ideal choice for microprocessor controlled analog systems. The use of CMOS allows the addition of more digital logic functionality on to the same die as the analog circuitry to minimize external parts requirements. The inherently low power consumption is also a big factor for battery operation and low heat generation in large scale systems.

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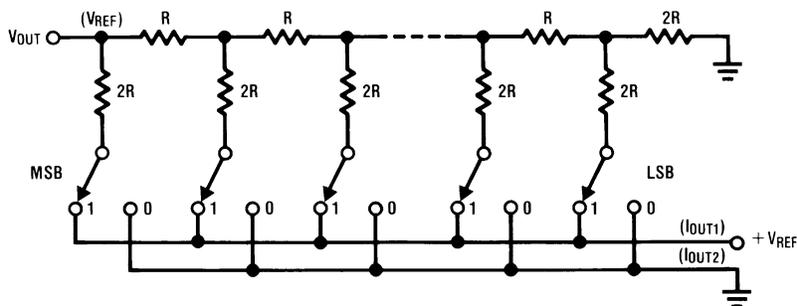


Figure 2. Operating the Ladder “Backwards” to Serve as a Voltage-Switching Network

Since the output is now a voltage rather than a current, an output op amp is not necessarily required, but the DAC's output impedance is fairly high (equal to its specified reference input resistance of 10k to 20k), so an op amp may be required for buffering purposes. Figure 4 shows a single-supply DAC with an output amplifier providing buffering and gain for a more useful 0V to 10V output from a 2.5V reference. The LM336 reference diode is biased through the internal feedback resistor between the I_{OUT1} pin and the R_{fb} pin. The zero-code output voltage is limited by the lower output saturation voltage of the LM358 op amp. The 2k pull-down load resistor helps to reduce this voltage to 10 mV or $\frac{1}{4}$ of an output LSB. Even with a 15V DAC supply, the digital inputs remain T²L compatible.

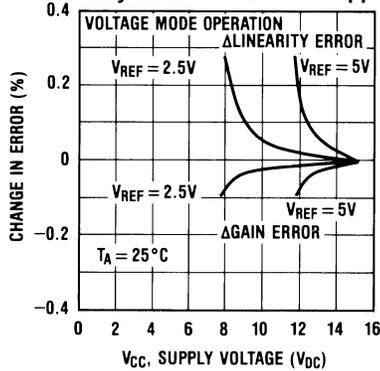
Closer inspection of Figure 2 shows that both I_{OUT1} and I_{OUT2} drive the ladder network in an identical manner. Each leg is connected to either I_{OUT1} or I_{OUT2} as controlled by the logic state of each digital input. If each I_{OUT} terminal is biased to separate reference potentials, the circuit of Figure 5 results. This is a single-supply DAC with an adjustable zero-code output offset voltage and adjustable output span to reserve the full resolution of the DAC for a range of voltages other than 0V to full-scale. An important point to note is that for an all ones code applied, only the voltage at I_{OUT1} is connected to the ladder and sets the output to 255/256 times the voltage of I_{OUT1} . With an all zeros code applied, only the voltage at I_{OUT2} drives the ladder, setting the output to 255/256 times this voltage. This non-interaction of the two inputs at the end-points makes calibration a breeze. The incremental analog output steps are automatically set to $(V_{MAX} - V_{MIN})/256$.

The buffers at the two reference inputs in Figure 5 isolate the code-dependent resistance to ground at I_{OUT1} and I_{OUT2} from the resistive string used to set V_{MAX} and V_{MIN} . The output responds in accordance to the following expression.

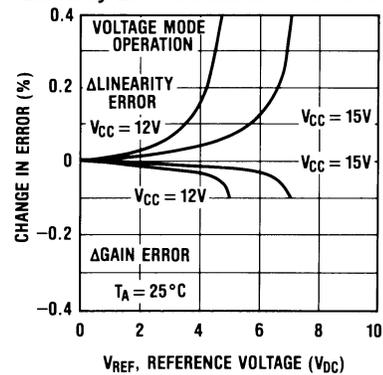
$$V_{OUT} = D/256 (V_{MAX} - V_{MIN}) + 255/256 V_{MIN} \quad (1)$$

Where D is the decimal equivalent of the 8-bit binary control word.

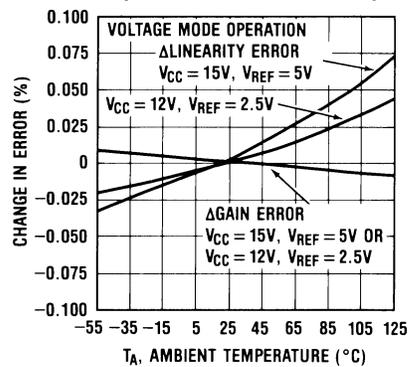
Gain and Linearity Error Variation vs Supply Voltage



Gain and Linearity Error Variation vs Reference Voltage



Gain and Linearity Error Variation vs Temperature



Note: For these curves, V_{REF} is the voltage applied to the I_{OUT1} terminal and I_{OUT2} is grounded.

Figure 3. The Effects of Bringing the VCC Supply and VREF Closer Together and Temperature Performance Using the DAC in the Voltage-Switching Mode

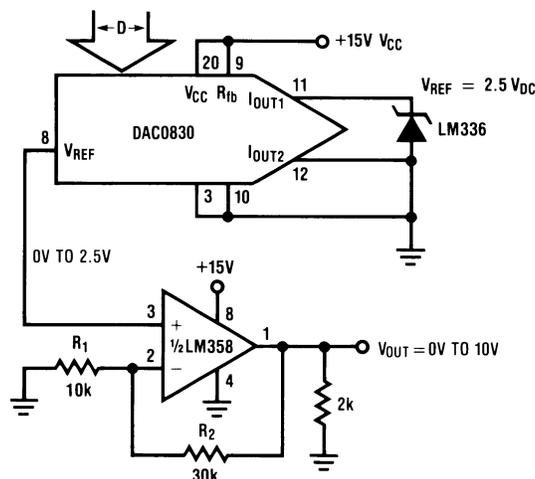


Figure 4. Obtaining 0V to 10V Output from a 2.5V Reference

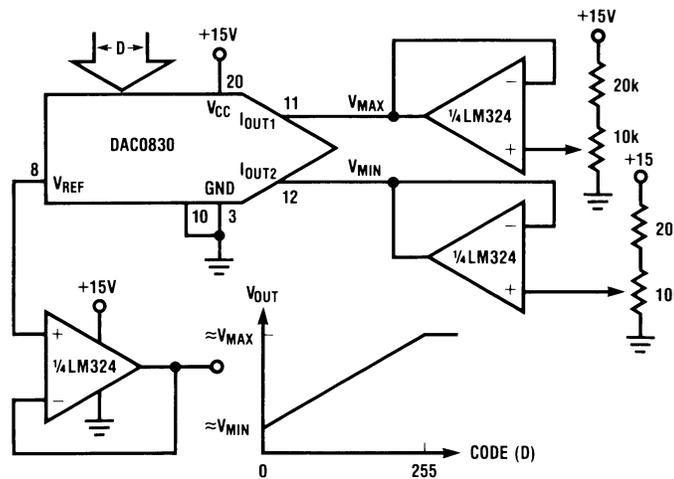
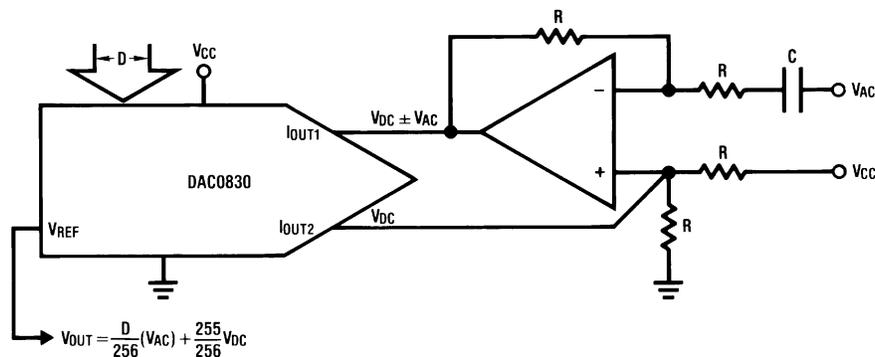


Figure 5. A Single-Supply DAC with Level Shift and Span Adjustable Output

A common requirement of single-supply systems is that the outputs of signal-conditioning amplifiers must be DC biased, typically to $\frac{1}{2}$ of the V_{CC} supply, to provide maximum unclipped AC signal swing. The circuit of Figure 6 shows how this dual-input voltage-switching DAC configuration can allow the digital input code to control the attenuation of an AC signal without significantly affecting the DC biasing level. If the voltage at I_{OUT2} is set to the DC level of the voltage at I_{OUT1} , then the term in Equation 1 which is controlled by the digital input code, D , reduces to just the AC signal at I_{OUT1} . The DC level at the output is $255/256$ times the DC level at the input.

The circuit of Figure 7 combines the advantages of low power consumption of the CMOS MICRODACs together with the non-interactive zero and full-scale adjustability of this voltage-switching technique. This circuit is an isolated 4 mA-20 mA current loop controller where the DAC sets the amount of current that flows through the loop, yet receives its own power from the very same loop.

Digital control and isolation are provided by a single optoisolator and a CMOS counter. The controlling processor must generate a clock and keep track of the number of clock pulses issued to the circuit to know what the loop current is at any time. On power-up the counter is reset to all zeros to give the processor a starting point, as well as to inherently provide a calibration point. When calibrating, potentiometer P1 would be set for the zero-code loop current of 4 mA. The processor would then issue exactly 255 clock pulses to the opto-isolator. Potentiometer P2 can then adjust the full-scale current value to 19.92 mA. If one more clock pulse is issued, the DAC input code returns to all zeros and the previously set value of 4 mA will flow, as this setting was unaffected by the full-scale adjustment.



Single-Supply DAC where the Digital Input Word Affects the Attenuation of an AC Signal without Significantly Altering its DC Biasing Level

Figure 6. Single-Supply DAC

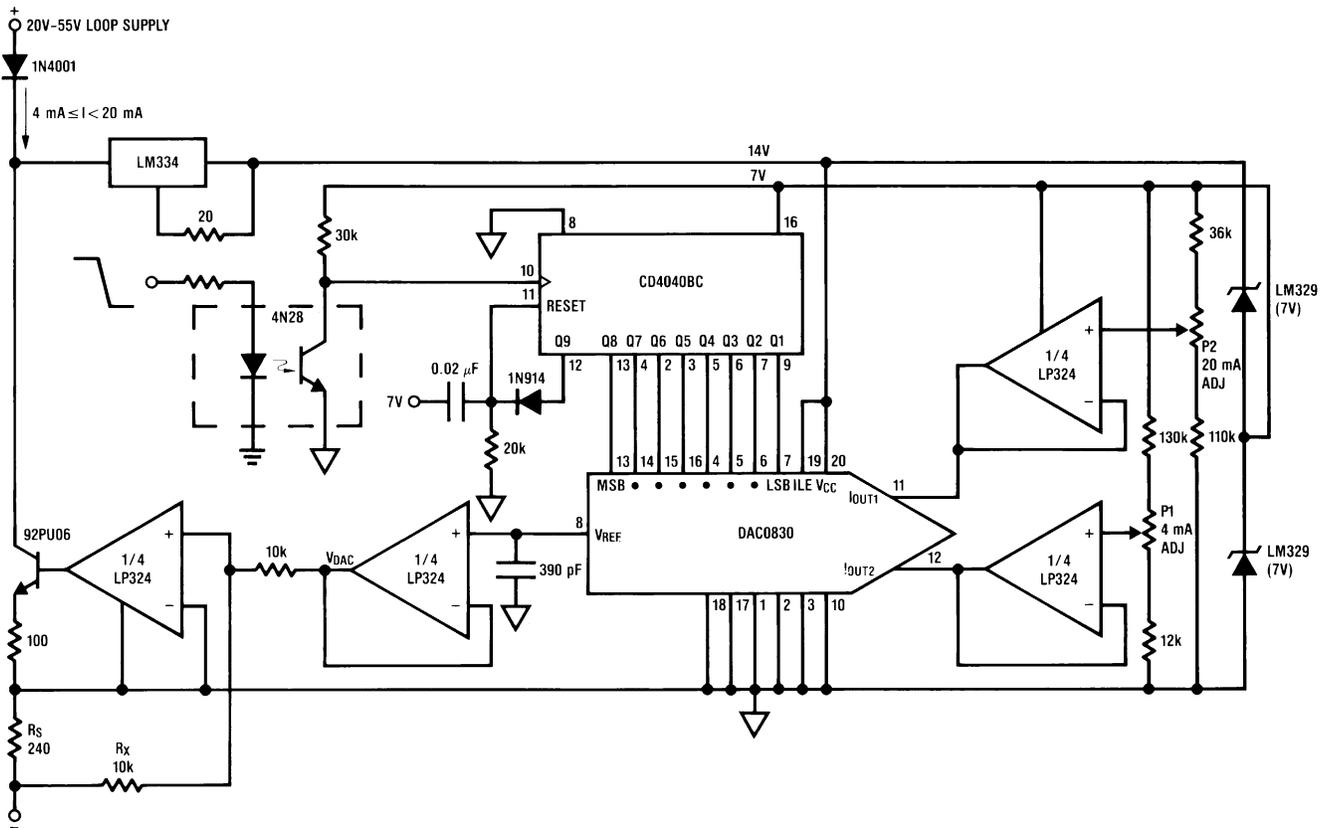


Figure 7. Easily Calibrated, Isolated 4 mA-20 mA Current Loop Controller

The NPN emitter-follower will conduct whatever level of current necessary to keep the voltage across resistor R_S equal to the voltage across resistor R_X . This voltage is equal to the output voltage at the V_{REF} pin of the DAC which can be determined from Equation 1. The actual loop current is:

$$I_{LOOP} = V_{DAC} / (R_S + R_X) \quad (2)$$

The second LM329 reference diode is used to bias the DAC V_{CC} supply higher than the voltages at I_{OUT1} and I_{OUT2} to preserve linearity.

Finally, what if a D to A function is required, but only a single 5V supply is available and minimal supply current is a primary concern (battery powered instrumentation is a good example)? The voltage-switching techniques previously described are not suitable because not enough voltage is available to properly bias the DAC. A CMOS DAC is still attractive for its low supply current requirements and if it can be operated in the standard current switching configuration, a single 5V supply is sufficient. But how about the voltage inversion and the requirement for negative supply potential?

By taking advantage of an age-old technique of clocking a diode-capacitor network connected as a DC to DC voltage inverter, a low current negative supply can be generated. In the circuit of Figure 8, 2 diodes and 2 capacitors are clocked by a CMOS Schmitt trigger oscillator and connected in such a fashion as to generate a -3.8V supply potential. This negative supply is used only to bias a low current LM385-2.5V reference diode to provide the DAC with a stable negative reference. Now the inversion of the output current-to-voltage converter will generate a positive output ranging from 0V to 2.5V as a function of the digital input code.

The amount of ripple that may appear at the reference input is a function of the dynamic impedance of the LM385, the clock frequency and the size of the switching capacitors. For the component values shown, the clock frequency is approximately 1 kHz and the ripple on the reference is 7 mV peak to peak. This ripple is cleanly filtered by the bypass cap around the feedback resistor of the output amplifier. The output op amp is part of a new low power quad, the LP324, which is ideal for its ability to common-mode to ground on the inputs and swing very close to ground at its output. If an extra CMOS Schmitt inverter is not readily available, the oscillator function can be implemented with another of the amplifiers in the op amp package. The total supply current of this single-supply DAC is on the order of 1.5 mA with no output load.

With this technique even the 12-bit DAC1230 can be used with no linearity degradation which would be apparent in the voltage-switching techniques.

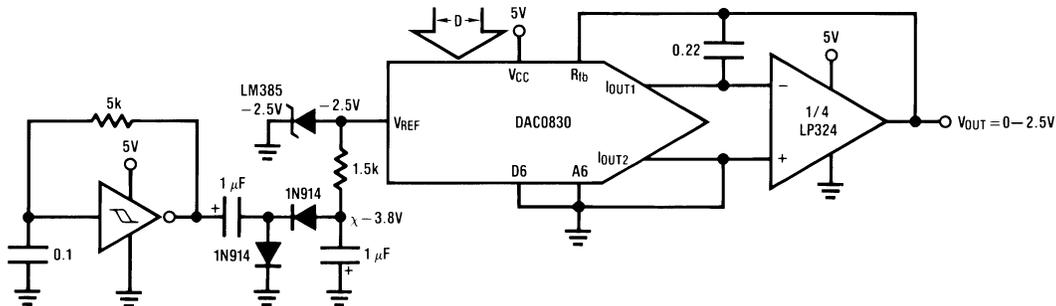


Figure 8. Single 5V Supply, 8-Bit CMOS DAC

2 Reference

1. Sevastopoulos, N.; Cecil, J.; and Fredericksen, T., "An Unusual Circuit Configuration Improves CMOS-MDAC Performance", EDN Magazine, March 5, 1979, pg. 77.

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